



Ultra Low Profile 0805 20dB Directional Coupler

Description:

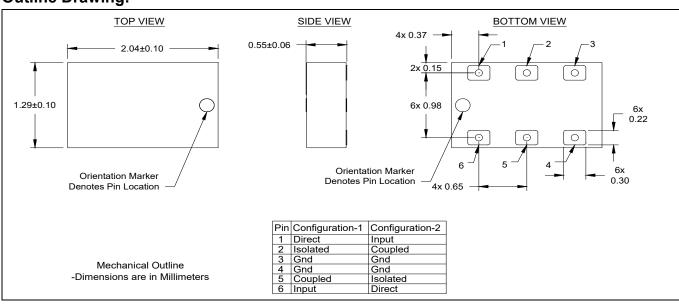
The DC1722J5020AHF is a low cost, low profile sub-miniature high performance 20 dB directional coupler in an easy to use surface mount package. It is designed for 1700 – 1900MHz applications including: WCDMA, CDMA, IMT2000, UMTS and GSM1800 / 1900 applications. The DC1722J5020AHF is ideal for power detection, signal injection and other applications where low insertion loss signal monitoring is required. The DC1722J5020AHF is available on tape and reel for pick and place high volume manufacturing. All of the Xinger components are constructed from ceramic filled PTFE composites which possess excellent electrical and mechanical stability. All parts have been subjected to rigorous qualification testing and units are 100% RF tested.

Detailed Electrical Specifications:

Features:	•	ROOM (25°C)											
 1700 – 2200 MHz Mean Coupling 20dB 	Frequency (MHz)	Mea	n Coup (dB)	oling	Inse	rtion (dB)	Returr (d	Loss B)		tivity B)	Frequ Sens (d	itivity	Power Handling (watts)
0.58mm Height			1	1		l		l		l	,	, 	@85°C
Profile		Min	Тур.	Max	Тур.	Max	Typ.	Min	Тур.	Min	Тур.	Max	Max
Ultra Low Insertion													
Loss	1700 - 2200	19.0	19.9	20.8	0.17	0.26	22.5	17.0	21.4	14.9	0.15	0.17	2
Surface Mountable		10.0	10.0	20.0	0.17	0.20		17.0		1 1.0	0.10	0.11	_
Tape & Reel	1805 - 1880	18.9	19.8	20.7	0.13	0.20	29.4	20.0	23.0	15.3	0.02	0.02	2
RoHS					01.0	0.20					0.02	0.02	_
• Compliant	1930 - 1990	18.9	19.8	20.7	0.14	0.22	26.1	19.2	25.8	16.2	0.01	0.01	2
Halogen Free	0440 0470	40.0	00.0	00.0	0.40	0.05	00.0	47.0	07.5	40.4	0.05	0.05	0
• -55°C to 140°C	2110 - 2170	19.0	20.0	20.9	0.16	0.25	23.0	17.3	27.5	19.1	0.05	0.05	2

^{*} Specifications subject to change without notice.

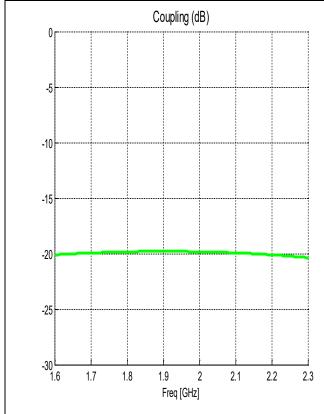
Outline Drawing:

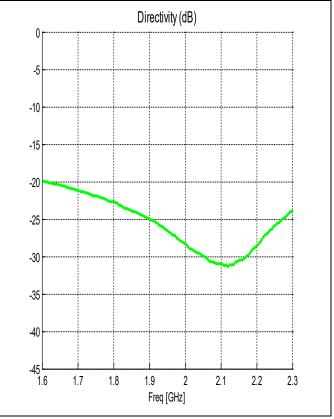


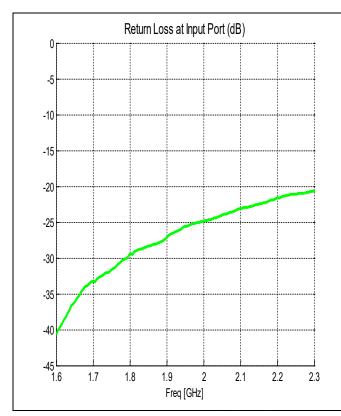
^{**}Specification based on performance of unit properly installed on microstrip printed circuit boards with 50 Ω nominal impedance.

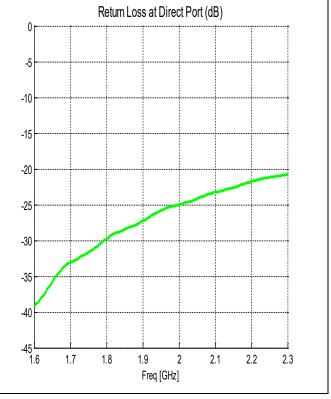


Typical Performance: 1600 MHz to 2300 MHz (Configuration 1)









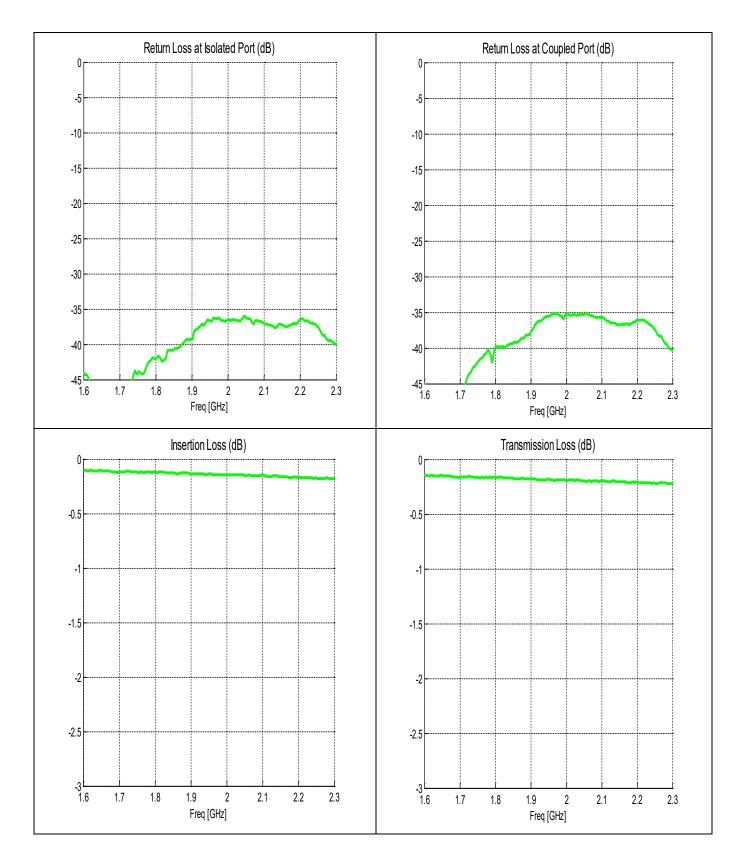
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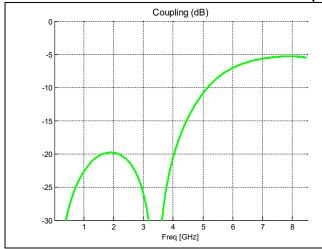
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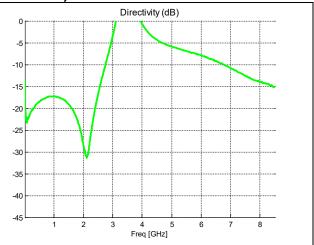


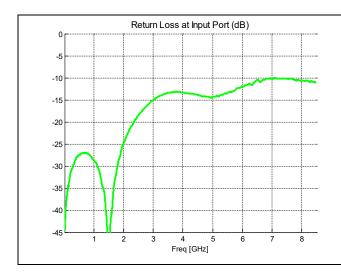


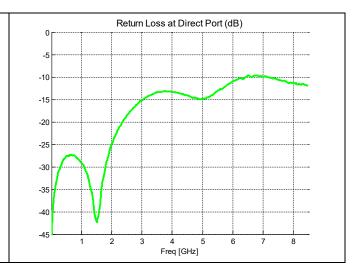


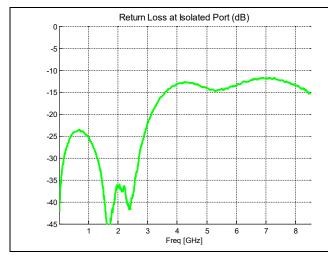
Wide Band Performance: 0 to 8500 MHz (Configuration 1)

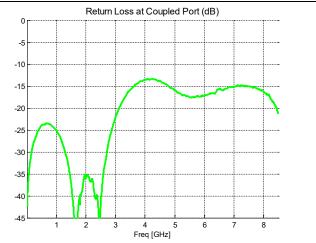




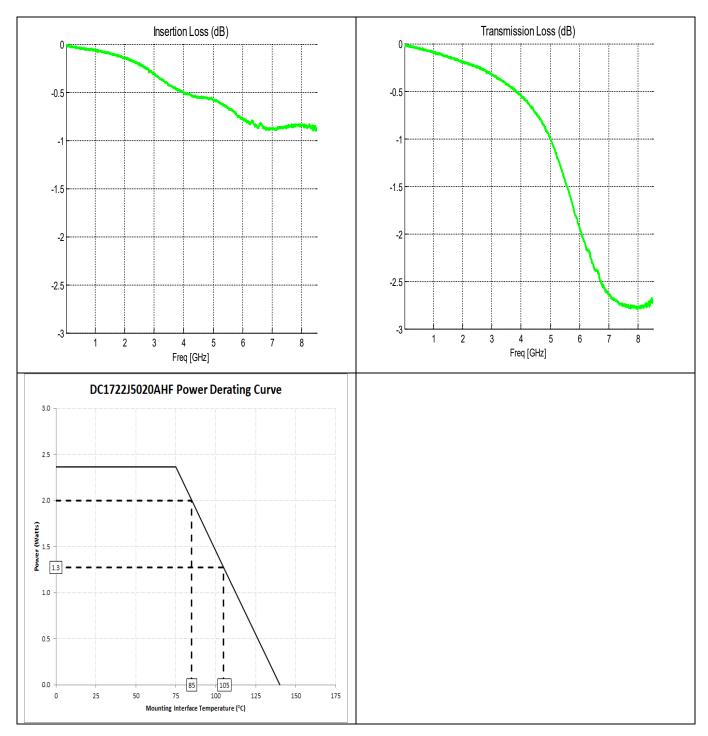












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Definition of Measured Specifications

Parameter	Definition	Mathematical Representation				
Return Loss	The impedance match of the coupler to a 50Ω system. Return Loss is an alternate means to express VSWR.	Return Loss(dB) = $20\log \frac{VSWR + 1}{VSWR - 1}$				
Directivity	The power at the isolated port divided by the power at the coupled port	$Directivity(dB) = 10log \frac{P_{iso}}{P_{cpl}}$				
Insertion Loss	The input power divided by the sum of the power at the two output ports.	Insertion Loss(dB) = $10\log \frac{P_{in}}{P_{cpl} + P_{direct}}$				
Moon Counling	At a given frequency (ω_n) , coupling is the input power divided by the power at the coupled port.	Coupling(dB) = $C(\omega_n) = 10\log \frac{P_{in}(\omega_n)}{P_{cpl}(\omega_n)}$				
Mean Coupling	Mean coupling is the average value of the coupling values in the band. N is the number of frequencies in the band.	Mean Coupling(dB) = $\frac{\sum_{n=1}^{N} C(\omega_n)}{N}$				
Transmission Loss	The input power divided by the power at the direct port	Transmission Loss(dB) = $10\log \frac{P_{in}}{P_{direct}}$				
Frequency sensitivity	The decibel difference between the maximum in band coupling value and the minimum in band coupling value.	(Max Coupling (dB) - Min Coupling (dB))/2				

^{*100%} RF test is performed on configuration 1 where port 1 is connected to pin1, port 2 is connected to pin 2, port 3 is connected to pin 5 and port 4 is connected to pin 6.

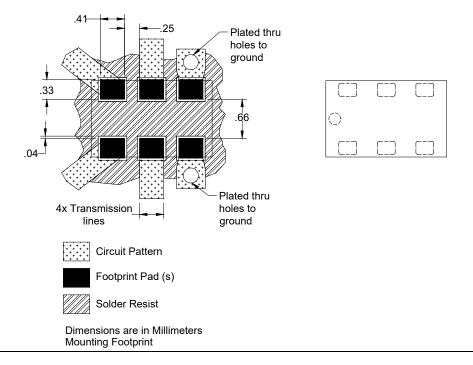


Mounting Configuration:

In order for Xinger surface mount components to work optimally, the proper impedance transmission lines must be used to connect to the RF ports. If this condition is not satisfied, insertion loss, Isolation and VSWR may not meet published specifications.

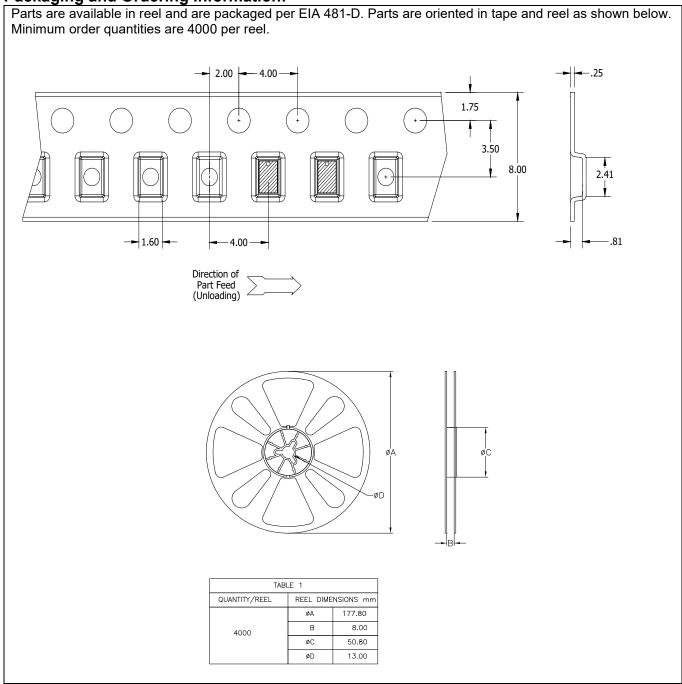
All of the Xinger components are constructed from organic PTFE based composites which possess excellent electrical and mechanical stability. Xinger components are compliant to a variety of ROHS and Green standards and ready for Pb-free soldering processes. Pads are Gold plated with a Nickel barrier.

An example of the PCB footprint used in the testing of these parts is shown below. In specific designs, the transmission line widths need to be adjusted to the unique dielectric coefficients and thicknesses as well as varying pick and place equipment tolerances.





Packaging and Ordering Information:



Contact us:

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